ATF-34143 Low Noise Pseudomorphic HEMT in a Surface Mount Plastic Package

Data Sheet



Description

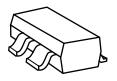
Avago's ATF-34143 is a high dynamic range, low noise PHEMT housed in a 4-lead SC-70 (SOT-343) surface mount plastic package.

Based on its featured performance, ATF-34143 is ideal for the first stage of base station LNA due to the excellent combination of low noise figure and high linearity^[1]. The device is also suitable for applications in Wireless LAN, WLL/RLL, MMDS, and other systems requiring super low noise figure with good intercept in the 450 MHz to 10 GHz frequency range.

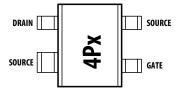
Note:

1. From the same PHEMT FET family, the larger geometry ATF-33143 may also be considered either for the higher linearity performance or easier circuit design for stability in the lower frequency bands (800–900 MHz).

Surface Mount Package - SOT-343



Pin Connections and Package Marking



Note: Top View. Package marking provides orientation and identification.

"4P" = Device code

"x" = Date code character. A new character is assigned for each month, year.

Features

- Lead-free Option Available
- Low Noise Figure
- Excellent Uniformity in Product Specifications
- 800 micron Gate Width
- Low Cost Surface Mount Small Plastic Package SOT-343 (4 lead SC-70)
- Tape-and-Reel Packaging Option Available

Specifications

1.9 GHz; 4V, 60 mA (Typ.)

- 0.5 dB Noise Figure
- 17.5 dB Associated Gain
- 20 dBm Output Power at 1 dB Gain Compression
- 31.5 dBm Output 3rd Order Intercept

Applications

- Tower Mounted Amplifier and Low Noise Amplifier for GSM/TDMA/CDMA Base Stations
- LNA for Wireless LAN, WLL/RLL and MMDS Applications
- General Purpose Discrete PHEMT for other Ultra Low Noise Applications



Attention: Observe precautions for handling electrostatic sensitive devices. ESD Machine Model (Class A) ESD Human Body Model (Class 1) Refer to Avago Application Note A004R: *Electrostatic Discharge Damage and Control.*

ATF-34143 Absolute Maximum Ratings^[1]

Symbol	Parameter	Units	Absolute Maximum
V _{DS}	Drain - Source Voltage ^[2]	V	5.5
V _{GS}	Gate - Source Voltage ^[2]	V	-5
V_{GD}	Gate Drain Voltage ^[2]	V	-5
I _D	Drain Current ^[2]	mA	I _{dss} ^[3]
P _{diss}	Total Power Dissipation ^[4]	mW	725
P _{in max}	RF Input Power	dBm	17
Т _{СН}	Channel Temperature	°C	160
T _{STG}	Storage Temperature	°C	-65 to 160
θ_{jc}	Thermal Resistance ^[5]	°C/W	165

Notes:

- Operation of this device above any one of these parameters may cause permanent damage.
- 2. Assumes DC quiescent conditions.
- 3. $V_{GS} = 0$ volts.
- 4. Source lead temperature is 25°C. Derate 6 mW/°C for $T_L > 40$ °C.
- Thermal resistance measured using 150°C Liquid Crystal Measurement method.
- Under large signal conditions, V_{GS} may swing positive and the drain current may exceed l_{dss}. These conditions are acceptable as long as the maximum P_{diss} and P_{in max} ratings are not exceeded.

Product Consistency Distribution Charts^[7]

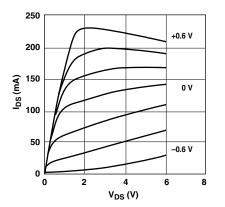


Figure 1. Typical/Pulsed I-V Curves^[6]. $(V_{GS} = -0.2 V \text{ per step})$

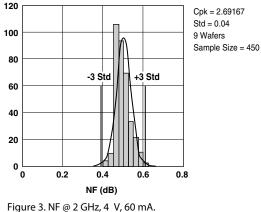
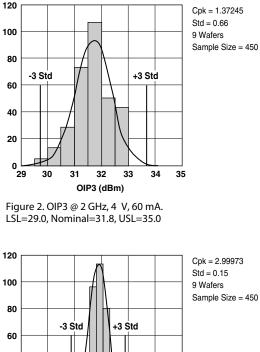


Figure 3. NF @ 2 GHz, 4 V, 60 mA. LSL=0.1, Nominal=0.47, USL=0.8



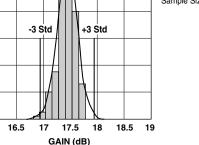


Figure 4. Gain @ 2 GHz, 4 V, 60 mA. LSL=16.0, Nominal=17.5, USL=19.0

Notes:

7. Distribution data sample size is 450 samples taken from 9 different wafers. Future wafers allocated to this product may have nominal values anywhere within the upper and lower spec limits.

40

20 0

16

8. Measurements made on production test board. This circuit represents a trade-off between an optimal noise match and a realizeable match based on production test requirements. Circuit losses have been de-embedded from actual measurements.

ATF-34143 Electrical Specifications

Symbol	Parameters and Test Con	ditions		Units	Min.	Typ. ^[2]	Max
I _{dss} ^[1]	Saturated Drain Current		$V_{DS} = 1.5 \text{ V}, V_{GS} = 0 \text{ V}$	mA	90	118	145
$V_{P}^{[1]}$	Pinchoff Voltage		V_{DS} = 1.5 V, I_{DS} = 10% of I_{dss}	V	-0.65	-0.5	-0.3
I _d	Quiescent Bias Current		$V_{GS} = -0.34 \text{ V}, V_{DS} = 4 \text{ V}$	mA	_	60	
$g_m^{[1]}$	Transconductance		$V_{DS} = 1.5 \text{ V}, \text{ g}_{\text{m}} = \text{I}_{\text{dss}}/\text{V}_{\text{P}}$	mmho	180	230	
I _{GDO}	Gate to Drain Leakage C	Current	$V_{GD} = 5 V$	μΑ			500
I _{gss}	Gate Leakage Current		$V_{GD} = V_{GS} = -4 V$	μΑ	—	30	300
NF	Noise Figure	f = 2 GHz	$V_{DS} = 4 V$, $I_{DS} = 60 mA$ $V_{DS} = 4 V$, $I_{DS} = 30 mA$	dB		0.5 0.5	0.8
		f = 900 MHz	$V_{DS} = 4 V, I_{DS} = 60 mA$	dB		0.4	
G _a	Associated Gain	f = 2 GHz	$V_{DS} = 4 V, I_{DS} = 60 mA$ $V_{DS} = 4 V, I_{DS} = 30 mA$	dB	16	17.5 17	19
		f = 900 MHz	$V_{DS} = 4 V, I_{DS} = 60 mA$	dB		21.5	
OIP3	Output 3 rd Order Intercept Point ^[3]	f = 2 GHz +5 dBm P _{out} /Tone	$V_{DS} = 4 V$, $I_{DS} = 60 mA$ $V_{DS} = 4 V$, $I_{DS} = 30 mA$	dBm	29	31.5 30	
		f = 900 MHz +5 dBm P _{out} /Tone	$V_{DS} = 4 V$, $I_{DS} = 60 mA$	dBm		31	
P_{1dB}	1 dB Compressed Intercept Point ^[3]	f = 2 GHz	$V_{DS} = 4 V$, $I_{DS} = 60 mA$ $V_{DS} = 4 V$, $I_{DS} = 30 mA$	dBm		20 19	
		f = 900 MHz	$V_{DS} = 4 V$, $I_{DS} = 60 mA$	dBm		18.5	

 $T_A = 25^{\circ}$ C, RF parameters measured in a test circuit for a typical device

Notes:

1. Guaranteed at wafer probe level

2. Typical value determined from a sample size of 450 parts from 9 wafers.

3. Using production test board.

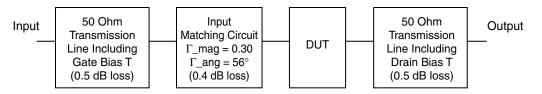
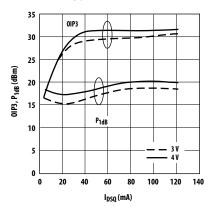
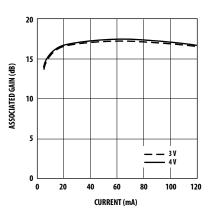
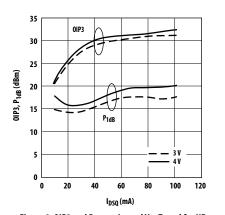


Figure 5. Block diagram of 2 GHz production test board used for Noise Figure, Associated Gain, P1dB, and OIP3 measurements. This circuit represents a trade-off between an optimal noise match and associated impedance matching circuit losses. Circuit losses have been de-embedded from actual measurements.

ATF-34143 Typical Performance Curves







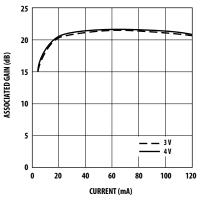


Figure 10. Associated Gain vs. Current (I_d) and Voltage (V_D) at 900 MHz. $^{[1,2]}$

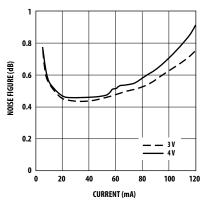


Figure 8. Noise Figure vs. Current (I_d) and Voltage (V_{DS}) at 2 GHz. $^{[1,2]}$

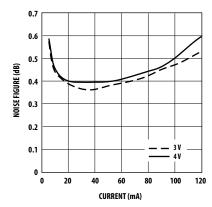
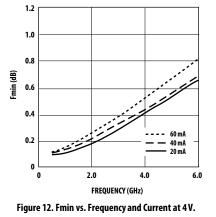
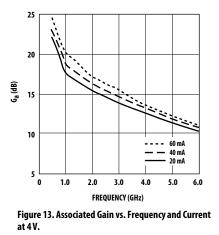


Figure 11. Noise Figure vs. Current (I_d) and Voltage ($V_{\rm NS}$) at 900 MHz. ^[1,2]

Figure 9. OIP3 and P_{1dB} vs. I_{DS} and V_{DS} Tuned for NF @ 4 V, 60 mA at 900 MHz. $^{[1,2]}$



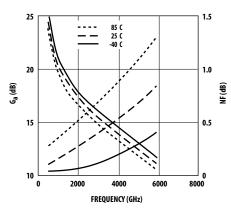


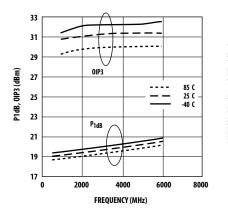


1. Measurements made on a fixed toned production test board that was tuned for optimal gain match with reasonable noise figure at 4V, 60 mA bias. This circuit represents a trade-off between optimal noise match, maximum gain match, and a realizable match based on production test board requirements. Circuit losses have been de-embedded from actual measurements.

2. P_{1dB} measurements are performed with passive biasing. Quicescent drain current, $I_{DSQ'}$ is set with zero RF drive applied. As P_{1dB} is approached, the drain current may increase or decrease depending on frequency and dc bias point. At lower values of I_{DSQ} the device is running closer to class B as power output approaches P_{1dB} . This results in higher PAE (power added efficiency) when compared to a device that is driven by a constant current source as is typically done with active biasing. As an example, at a $V_{DS} = 4$ V and $I_{DSQ} = 10$ mA, I_d increases to 62 mA as a P_{1dB} of +19 dBm is approached.

ATF-34143 Typical Performance Curves, continued





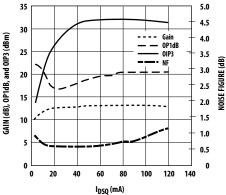
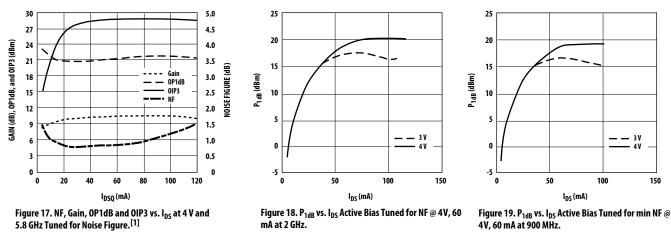


Figure 14. Fmin and Ga vs. Frequency and Temperature at V_{DS} = 4V, I_{DS} = 60 mA.

Figure 15. P_{1dB} , IP3 vs. Frequency and Temperature at V_{DS} = 4 V, I_{DS} = 60 mA.^[1]

Figure 16. NF, Gain, OP1dB and OIP3 vs. I_{DS} at 4 V and 3.9 GHz Tuned for Noise Figure.^[1]



Note:

1. P_{1dB} measurements are performed with passive biasing. Quicescent drain current, $I_{DSQ'}$ is set with zero RF drive applied. As P_{1dB} is approached, the drain current may increase or decrease depending on frequency and dc bias point. At lower values of I_{DSQ} the device is running closer to class B as power output approaches P_{1dB} . This results in higher PAE (power added efficiency) when compared to a device that is driven by a constant current source as is typically done with active biasing. As an example, at a $V_{DS} = 4$ V and $I_{DSQ} = 10$ mA, I_d increases to 62 mA as a P_{1dB} of +19 dBm is approached.

Freq (GHz)	P _{1dB} (dBm)	l _d (mA)	G _{1dB} (dB)	PAE _{1dB} (%)	P _{3dBm} (dBm)	l _d (mA)	PAE _{3dB} (%)	Gamma Out_mag (Mag)	Gamma Out_ang (Degrees)
0.9	20.9	114	25.7	27	22.8	108	44	0.34	136
1.5	21.7	115	21.9	32	23.1	95	53	0.31	152
1.8	21.3	111	20.5	30	23.0	105	47	0.30	164
2	22.0	106	19.5	37	23.7	115	50	0.28	171
4	22.7	110	12.7	40	23.6	111	47	0.26	-135
6	23.3	115	9.2	41	24.2	121	44	0.24	-66

ATF-34143 Power Parameters tuned for Power, $V_{DS} = 4 V$, $I_{DSQ} = 120 \text{ mA}$

ATF-34143 Power Parameters tuned for Power, $V_{DS} = 4 V$, $I_{DSQ} = 60 mA$

Freq (GHz)	P _{1dB} (dBm)	l _d (mA)	G _{1dB} (dB)	PAE _{1dB} (%)	P _{3dBm} (dBm)	l _d (mA)	PAE _{3dB} (%)	Gamma Out_mag (Mag)	Gamma Out_ang (Degrees)
0.9	18.2	75	27.5	22	20.5	78	36	0.48	102
1.5	18.7	58	24.5	32	20.8	59	51	0.45	117
1.8	18.8	57	23.0	33	21.1	71	45	0.42	126
2	18.8	59	22.2	32	21.9	81	47	0.40	131
4	20.2	66	13.9	38	22.0	77	48	0.25	-162
6	21.2	79	9.9	37	23.5	102	46	0.18	-77

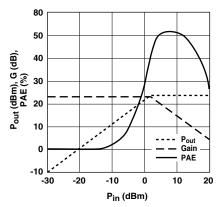


Figure 20. Swept Power Tuned for Power at 2 GHz, $V_{DS} = 4 V$, $I_{DSQ} = 120 mA$.

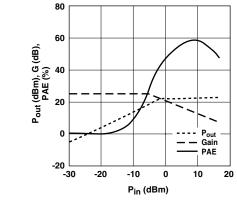


Figure 21. Swept Power Tuned for Power at 2 GHz, $V_{DS} = 4 V$, $I_{DSQ} = 60 mA$.

Notes:

- 1. P_{1dB} measurements are performed with passive biasing. Quicescent drain current, $I_{DSQ'}$ is set with zero RF drive applied. As P_{1dB} is approached, the drain current may increase or decrease depending on frequency and dc bias point. At lower values of I_{DSQ} the device is running closer to class B as power output approaches P_{1dB} . This results in higher PAE (power added efficiency) when compared to a device that is driven by a constant current source as is typically done with active biasing. As an example, at a $V_{DS} = 4$ V and $I_{DSQ} = 10$ mA, I_d increases to 62 mA as a P_{1dB} of +19 dBm is approached.
- 2. PAE(%) = ((Pout Pin)/Pdc) x 100
- 3. Gamma out is the reflection coefficient of the matching circuit presented to the output of the device.

Freq.	S	511		S ₂₁			S ₁₂		S	22	MSG/MAG
GHz	Mag.	Ang.	dB	Mag.	Ang.	dB	Mag.	Ang.	Mag.	Ang.	dB
0.5	0.96	-37	20.07	10.079	153	-29.12	0.035	68	0.40	-35	24.59
0.8	0.91	-60	19.68	9.642	137	-26.02	0.050	56	0.34	-56	22.85
1.0	0.87	-76	18.96	8.867	126	-24.29	0.061	48	0.32	-71	21.62
1.5	0.81	-104	17.43	7.443	106	-22.27	0.077	34	0.29	-98	19.85
1.8	0.78	-115	16.70	6.843	98	-21.62	0.083	28	0.28	-110	19.16
2.0	0.75	-126	16.00	6.306	90	-21.11	0.088	23	0.26	-120	18.55
2.5	0.72	-145	14.71	5.438	75	-20.45	0.095	15	0.25	-140	17.58
3.0	0.69	-162	13.56	4.762	62	-19.83	0.102	7	0.23	-156	16.69
4.0	0.65	166	11.61	3.806	38	-19.09	0.111	-8	0.22	174	15.35
5.0	0.64	139	10.01	3.165	16	-18.49	0.119	-21	0.22	146	14.25
6.0	0.65	114	8.65	2.706	-5	-18.06	0.125	-35	0.23	118	13.35
7.0	0.66	89	7.33	2.326	-27	-17.79	0.129	-49	0.25	91	10.91
8.0	0.69	67	6.09	2.017	-47	-17.52	0.133	-62	0.29	67	9.71
9.0	0.72	48	4.90	1.758	-66	-17.39	0.135	-75	0.34	46	8.79
10.0	0.75	30	3.91	1.568	-86	-17.08	0.140	-88	0.39	28	8.31
11.0	0.77	10	2.88	1.393	-105	-16.95	0.142	-103	0.43	10	7.56
12.0	0.80	-10	1.74	1.222	-126	-16.95	0.142	-118	0.47	-10	6.83
13.0	0.83	-29	0.38	1.045	-145	-17.39	0.135	-133	0.53	-28	6.18
14.0	0.85	-44	-0.96	0.895	-161	-17.86	0.128	-145	0.58	-42	5.62
15.0	0.86	-55	-2.06	0.789	-177	-18.13	0.124	-156	0.62	-57	5.04
16.0	0.85	-72	-3.09	0.701	166	-18.13	0.124	-168	0.65	-70	3.86
17.0	0.85	-88	-4.22	0.615	149	-18.06	0.125	177	0.68	-85	3.00
18.0	0.88	-101	-5.71	0.518	133	-18.94	0.113	165	0.71	-103	2.52

ATF-34143 Typical Scattering Parameters, $V_{DS} = 3 V$, $I_{DS} = 20 mA$

ATF-34143 Typical Noise Parameters

 $V_{DS} = 3 V, I_{DS} = 20 mA$

Eroa	E	Г		D	6	25
Freq. GHz	F _{min} dB	Г. Mag.	Ang.	R _{n/50} -	G _a dB	20 MSG
0.5	0.10	0.90	13	0.16	21.8	
0.9	0.11	0.85	27	0.14	18.3	
1.0	0.11	0.84	31	0.13	17.8	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5
1.5	0.14	0.77	48	0.11	16.4	Bos 5
1.8	0.17	0.74	57	0.10	16.0	
2.0	0.19	0.71	66	0.09	15.6	
2.5	0.23	0.65	83	0.07	14.8	-5
3.0	0.29	0.59	102	0.06	14.0	-10
4.0	0.42	0.51	138	0.03	12.6	0 2 4 6 8 10 12 14 16
5.0	0.54	0.45	174	0.03	11.4	FREQUENCY (GHz)
6.0	0.67	0.42	-151	0.05	10.3	Figure 23. MSG/MAG and $ S_{21} ^2$ vs.
7.0	0.79	0.42	-118	0.10	9.4	Frequency at 3 V, 20 mA.
8.0	0.92	0.45	-88	0.18	8.6	
9.0	1.04	0.51	-63	0.30	8.0	
10.0	1.16	0.61	-43	0.46	7.5	

Notes:

1. Fmin values at 2 GHz and higher are based on measurements while the Fmins below 2 GHz have been extrapolated. The Fmin values are based on a set of 16 noise figure measurements made at 16 different impedances using an ATN NP5 test system. From these measurements a true Fmin is calculated. Refer to the noise parameter application section for more information.

Freq.	S	11		S ₂₁			S ₁₂		S	22	MSG/MAG
GHz	Mag.	Ang.	dB	Mag.	Ang.	dB	Mag.	Ang.	Mag.	Ang.	dB
0.5	0.96	-40	21.32	11.645	151	-30.46	0.030	68	0.29	-43	25.89
0.8	0.89	-64	20.79	10.950	135	-27.33	0.043	56	0.24	-70	24.06
1.0	0.85	-81	19.96	9.956	124	-25.68	0.052	49	0.24	-88	22.82
1.5	0.79	-109	18.29	8.209	104	-23.61	0.066	36	0.23	-118	20.95
1.8	0.76	-121	17.50	7.495	96	-22.97	0.071	32	0.23	-130	20.24
2.0	0.74	-131	16.75	6.876	88	-22.38	0.076	27	0.22	-141	19.57
2.5	0.70	-150	15.39	5.880	74	-21.51	0.084	19	0.22	-160	18.45
3.0	0.67	-167	14.19	5.120	61	-20.92	0.090	12	0.22	-176	17.55
4.0	0.64	162	12.18	4.063	38	-19.83	0.102	-1	0.21	157	16.00
5.0	0.64	135	10.54	3.365	16	-19.02	0.112	-14	0.22	131	14.78
6.0	0.65	111	9.15	2.867	-5	-18.34	0.121	-28	0.24	105	12.91
7.0	0.66	87	7.80	2.454	-26	-17.86	0.128	-42	0.28	81	11.03
8.0	0.69	65	6.55	2.125	-46	-17.46	0.134	-55	0.32	60	9.93
9.0	0.73	46	5.33	1.848	-65	-17.20	0.138	-69	0.37	40	9.07
10.0	0.76	28	4.33	1.647	-84	-16.83	0.144	-84	0.41	23	8.59
11.0	0.78	9	3.30	1.462	-104	-16.65	0.147	-99	0.45	5	7.84
12.0	0.80	-11	2.15	1.281	-123	-16.65	0.147	-114	0.50	-14	7.15
13.0	0.83	-30	0.79	1.095	-142	-17.08	0.140	-130	0.55	-31	6.50
14.0	0.86	-44	-0.53	0.941	-158	-17.52	0.133	-142	0.60	-45	5.96
15.0	0.87	-56	-1.61	0.831	-174	-17.72	0.130	-154	0.64	-59	5.39
16.0	0.86	-72	-2.60	0.741	169	-17.72	0.130	-166	0.66	-73	4.21
17.0	0.86	-88	-3.72	0.652	153	-17.79	0.129	179	0.69	-88	3.43
18.0	0.88	-102	-5.15	0.553	137	-18.64	0.117	166	0.72	-105	2.95

ATF-34143 Typical Scattering Parameters, $V_{DS} = 3 V$, $I_{DS} = 40 mA$

ATF-34143 Typical Noise Parameters

 $V_{DS} = 3 V, I_{DS} = 40 mA$

						-	, j
	G _a 30		R _{n/50}		Γ	F _{min}	Freq.
	dB 25 +	dB	-	Ang.	Mag.	dB	GHz
MSG	23.0 20	23.0	0.16	13	0.87	0.10	0.5
	19.6 g	19.6	0.13	28	0.82	0.13	0.9
	19.6 pu constraints for the second se	19.2	0.13	32	0.80	0.14	1.0
MAG	17.7 N 10	17.7	0.1	50	0.73	0.17	1.5
S ₂₁	17.1 🦉 🖉 🚽	17.1	0.09	61	0.70	0.21	1.8
	16.7 o –	16.7	0.08	68	0.66	0.23	2.0
	15.8	15.8	0.06	87	0.60	0.29	2.5
	14.9 -5	14.9	0.05	106	0.54	0.35	3.0
2 4 6 8 10 12 14 16	13.4 -10	13.4	0.03	144	0.46	0.47	4.0
FREQUENCY (GHz)	12.1	12.1	0.03	-178	0.41	0.6	5.0
24. MSG/MAG and $ S_{21} ^2$ vs.	10.9 Eiguro	10.9	0.06	-142	0.39	0.72	6.0
ency at 3 V, 40 mA.		9.9	0.12	-109	0.41	0.85	7.0
•	9.1	9.1	0.21	-80	0.45	0.97	8.0
	8.4	8.4	0.34	-56	0.52	1.09	9.0
	8.0	8.0	0.50	-39	0.61	1.22	10.0

Notes:

1. Fmin values at 2 GHz and higher are based on measurements while the Fmins below 2 GHz have been extrapolated. The Fmin values are based on a set of 16 noise figure measurements made at 16 different impedances using an ATN NP5 test system. From these measurements a true Fmin is calculated. Refer to the noise parameter application section for more information.

	· · ·	-									
Freq.	2	511		S ₂₁			S ₁₂		S	22	MSG/MAG
GHz	Mag.	Ang.	dB	Mag.	Ang.	dB	Mag.	Ang.	Mag.	Ang.	dB
0.5	0.95	-40	21.56	11.973	151	0.03	0.030	68	0.33	-39	26.01
0.8	0.89	-65	21.02	11.252	135	0.04	0.042	56	0.27	-63	24.28
1.0	0.85	-82	20.19	10.217	123	0.05	0.051	48	0.26	-80	23.02
1.5	0.78	-109	18.49	8.405	104	0.06	0.064	36	0.24	-109	21.18
1.8	0.73	-131	16.93	7.024	87	0.07	0.074	27	0.22	-131	20.46
2.0	0.70	-150	15.57	6.002	73	0.08	0.081	19	0.21	-150	19.77
2.5	0.67	-167	14.36	5.223	61	0.09	0.087	12	0.20	-167	18.70
3.0	0.64	162	12.34	4.141	37	0.10	0.098	-1	0.19	165	17.75
4.0	0.63	135	10.70	3.428	16	0.11	0.108	-13	0.20	138	16.26
5.0	0.64	111	9.32	2.923	-6	0.12	0.117	-27	0.21	111	15.02
6.0	0.66	87	7.98	2.506	-26	0.12	0.124	-41	0.24	86	12.93
7.0	0.69	65	6.74	2.173	-46	0.13	0.130	-54	0.29	63	11.14
8.0	0.72	47	5.55	1.894	-65	0.13	0.134	-68	0.34	42	10.09
9.0	0.76	28	4.55	1.689	-85	0.14	0.141	-82	0.38	26	9.24
10.0	0.78	9	3.53	1.501	-104	0.15	0.145	-97	0.42	8	8.79
11.0	0.80	-11	2.39	1.317	-124	0.15	0.145	-113	0.47	-11	8.09
12.0	0.84	-29	1.02	1.125	-143	0.14	0.140	-128	0.53	-29	7.35
13.0	0.86	-44	-0.30	0.966	-160	0.13	0.133	-141	0.58	-43	6.76
14.0	0.87	-56	-1.38	0.853	-176	0.13	0.130	-152	0.62	-58	6.19
15.0	0.86	-72	-2.40	0.759	167	0.13	0.131	-165	0.65	-71	5.62
16.0	0.86	-88	-3.53	0.666	151	0.13	0.130	-180	0.68	-86	4.43
17.0	0.89	-102	-4.99	0.563	134	0.12	0.119	168	0.71	-103	3.60
18.0	0.89	-101.85	-4.99	0.563	134	0.12	0.119	168	0.71	-103	3.15

ATF-34143 Typical Scattering Parameters, $V_{DS} = 4 V$, $I_{DS} = 40 mA$

ATF-34143 Typical Noise Parameters

$V_{DS} = 4 V, I_{DS} = 40 mA$

	30 –	6	D		Г	F	From
	30	Ga	R _{n/50}		Г	F _{min}	Freq.
	25	dB	-	Ang.	Mag.	dB	GHz
		22.8	0.16	13	0.87	0.10	0.5
	pu 20	19.4	0.14	27	0.82	0.13	0.9
	ଞ୍ଚ ୁ ଞ୍ଚି 15 –	18.9	0.13	31	0.80	0.14	1.0
	21 (WN)	17.4	0.11	49	0.73	0.17	1.5
S ₂₁ MAG	MSG/MAG and S ₂₁ (dB) 01 21 - 01	16.9	0.10	60	0.70	0.20	1.8
	5 -	16.4	0.09	67	0.66	0.22	2.0
	o	15.6	0.07	85	0.60	0.28	2.5
	_	14.8	0.05	104	0.54	0.34	3.0
2 4 6 8 10 12 14 16	-5 └- 0	13.3	0.03	142	0.45	0.45	4.0
FREQUENCY (GHz)		12.0	0.03	180	0.40	0.57	5.0
25. MSG/MAG and $ S_{21} ^2$ vs.	Figure	10.9	0.05	-144	0.38	0.69	6.0
ency at 4 V, 40 mA.		9.9	0.11	-111	0.39	0.81	7.0
		9.1	0.20	-82	0.43	0.94	8.0
		8.5	0.32	-57	0.51	1.06	9.0
		8.1	0.47	-40	0.62	1.19	10.0

Notes:

1. Fmin values at 2 GHz and higher are based on measurements while the Fmins below 2 GHz have been extrapolated. The Fmin values are based on a set of 16 noise figure measurements made at 16 different impedances using an ATN NP5 test system. From these measurements a true Fmin is calculated. Refer to the noise parameter application section for more information.

	/			, 03	. 03						
Freq.	S	11		S ₂₁			S ₁₂		S	22	MSG/MAG
GHz	Mag.	Ang.	dB	Mag.	Ang.	dB	Mag.	Ang.	Mag.	Ang.	dB
0.5	0.95	-41	21.91	12.454	150	-31.06	0.028	68	0.29	-41	26.48
0.8	0.89	-65	21.33	11.654	134	-28.18	0.039	57	0.24	-67	24.75
1.0	0.85	-83	20.46	10.549	123	-26.56	0.047	49	0.23	-84	23.51
1.5	0.78	-111	18.74	8.646	103	-24.44	0.060	38	0.21	-114	21.59
1.8	0.75	-122	17.92	7.873	95	-23.74	0.065	33	0.21	-125	20.83
2.0	0.73	-133	17.16	7.207	87	-23.22	0.069	29	0.20	-136	20.19
2.5	0.69	-151	15.78	6.149	73	-22.38	0.076	22	0.19	-155	19.08
3.0	0.67	-168	14.56	5.345	60	-21.62	0.083	15	0.19	-171	18.09
4.0	0.64	161	12.53	4.232	37	-20.54	0.094	3	0.18	162	16.53
5.0	0.63	134	10.88	3.501	16	-19.58	0.105	-10	0.19	135	15.23
6.0	0.64	111	9.49	2.983	-5	-18.79	0.115	-24	0.21	109	12.89
7.0	0.66	86	8.15	2.557	-26	-18.27	0.122	-38	0.24	84	11.22
8.0	0.69	65	6.92	2.217	-46	-17.79	0.129	-51	0.28	62	10.21
9.0	0.73	46	5.72	1.932	-65	-17.46	0.134	-65	0.33	42	9.36
10.0	0.76	28	4.73	1.723	-84	-16.95	0.142	-79	0.38	25	8.94
11.0	0.78	9	3.70	1.531	-104	-16.71	0.146	-94	0.42	7	8.23
12.0	0.81	-11	2.57	1.344	-124	-16.71	0.146	-111	0.47	-12	7.56
13.0	0.84	-30	1.20	1.148	-143	-17.02	0.141	-126	0.52	-29	6.94
14.0	0.86	-44	-0.12	0.986	-159	-17.46	0.134	-139	0.58	-43	6.37
15.0	0.87	-56	-1.21	0.870	-175	-17.59	0.132	-150	0.62	-58	5.78
16.0	0.86	-72	-2.21	0.775	168	-17.59	0.132	-163	0.65	-71	4.60
17.0	0.86	-88	-3.35	0.680	151	-17.65	0.131	-178	0.68	-86	3.79
18.0	0.89	-101.99	-4.81	0.575	135	-18.42	0.120	169	0.71	-104	3.33

ATF-34143 Typical Scattering Parameters, $V_{DS} = 4 V$, $I_{DS} = 60 \text{ mA}$

ATF-34143 Typical Noise Parameters

$V_{DS} = 4 V$, $I_{DS} = 60 mA$

Freq.	F _{min}	Γ	pt	R _{n/50}	G _a	30
GHz	dB	Mag.	Ang.	-	dB	25
0.5	0.11	0.84	15	0.14	24.5	20 MSG
0.9	0.14	0.78	30	0.12	20.7	Pun 15
1.0	0.15	0.77	34	0.12	20.2	MAG SW W2G S SS SS SS SS SS SS SS SS SS SS SS SS S
1.5	0.20	0.69	53	0.10	18.5	
1.8	0.23	0.66	62	0.10	17.7	Sg 5 5 521 521
2.0	0.26	0.62	72	0.09	17.2	0
2.5	0.33	0.55	91	0.07	16.3	-5
3.0	0.39	0.50	111	0.05	15.4	
4.0	0.53	0.43	149	0.03	13.7	-10 2 4 6 8 10 12 14 16 18
5.0	0.67	0.39	-173	0.04	12.3	FREQUENCY (GHz)
6.0	0.81	0.39	-137	0.07	11.1	Figure 26. MSG/MAG and $ S_{21} ^2$ vs.
7.0	0.96	0.42	-104	0.14	10.0	Frequency at 4 V, 60 mA.
8.0	1.10	0.47	-76	0.26	9.2	
9.0	1.25	0.54	-53	0.41	8.6	
10.0	1.39	0.62	-37	0.60	8.2	

Notes:

1. Fmin values at 2 GHz and higher are based on measurements while the Fmins below 2 GHz have been extrapolated. The Fmin values are based on a set of 16 noise figure measurements made at 16 different impedances using an ATN NP5 test system. From these measurements a true Fmin is calculated. Refer to the noise parameter application section for more information.

Noise Parameter Applications Information

F_{min} values at 2 GHz and higher are based on measurements while the F_{mins} below 2 GHz have been extrapolated. The F_{min} values are based on a set of 16 noise figure measurements made at 16 different impedances using an ATN NP5 test system. From these measurements, a true F_{min} is calculated. F_{min} represents the true minimum noise figure of the device when the device is presented with an impedance matching network that transforms the source impedance, typically 50Ω , to an impedance represented by the reflection coefficient Γ_{o} . The designer must design a matching network that will present Γ_0 to the device with minimal associated circuit losses. The noise figure of the completed amplifier is equal to the noise figure of the device plus the losses of the matching network preceding the device. The noise figure of the device is equal to F_{min} only when the device is presented with Γ_{o} . If the reflection coefficient of the matching network is other than Γ_{o} , then the noise figure of the device will be greater than F_{min} based on the following equation.

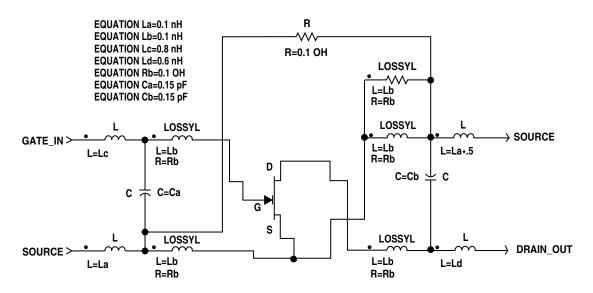
$$NF = F_{min} + 4R_n \frac{|\Gamma_s - \Gamma_o|^2}{Zo} \frac{|\Gamma_s - \Gamma_o|^2}{(|1 + \Gamma_o|^2)(1 - \Gamma_s|^2)}$$

Where R_n/Z_o is the normalized noise resistance, Γ_o is the optimum reflection coefficient required to produce F_{min} and Γ_s is the reflection coefficient of the source impedance actually presented to the device. The losses of the matching networks are non-zero and they will also add

to the noise figure of the device creating a higher amplifier noise figure. The losses of the matching networks are related to the Q of the components and associated printed circuit board loss. Γ_0 is typically fairly low at higher frequencies and increases as frequency is lowered. Larger gate width devices will typically have a lower Γ_0 as compared to narrower gate width devices.

Typically for FETs, the higher Γ_0 usually infers that an impedance much higher than 50Ω is required for the device to produce F_{min}. At VHF frequencies and even lower L Band frequencies, the required impedance can be in the vicinity of several thousand ohms. Matching to such a high impedance requires very hi-Q components in order to minimize circuit losses. As an example at 900 MHz, when airwwound coils (Q > 100) are used for matching networks, the loss can still be up to 0.25 dB which will add directly to the noise figure of the device. Using muiltilayer molded inductors with Qs in the 30 to 50 range results in additional loss over the airwound coil. Losses as high as 0.5 dB or greater add to the typical 0.15 dB F_{min} of the device creating an amplifier noise figure of nearly 0.65 dB. A discussion concerning calculated and measured circuit losses and their effect on amplifier noise figure is covered in Avago Application 1085.

ATF-34143 SC-70 4 Lead, High Frequency Nonlinear Model Optimized for 0.1–6.0 GHz



This model can be used as a design tool. It has been tested on MDS for various specifications. However, for more precise and accurate design, please refer to the measured data in this data sheet. For future improvements Avago reserves the right to change these models without prior notice.

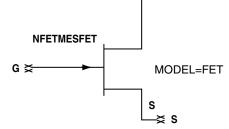
ATF-34143 Die Model

* STATZ MESFET MODEL * MODEL = FET						
IDS model NFET=yes PFET= IDSMOD=3 VTO=-0.95 BETA= Beta LAMBDA=0.09 ALPHA=4.0 B=0.8 TNOM=27 IDSTC= VBI=.7	Gate model DELTA=.2 GSCAP=3 CGS=cgs pF GDCAP=3 GCD=Cgd pF	Parasitics RG=1 RD=Rd RS=Rs LG=Lg nH LD=Ld nH LS=Ls nH CDS=Cds pF CRF=.1 RC=Rc	Breakdown GSFWD=1 GSREV=0 GDFWD=1 GDREV=0 VJR=1 IS=1 nA IR=1 nA IMAX=.1 XTI= N= EG=	Noise FNC=01e+6 R=.17 P=.65 C=.2		
Model scal factors	(W=FET width in mic	rons)		—≍ D		
QUATION Cds=0.						

EQUATION Beta=0.06*W/200 EQUATION Rd=200/W EQUATION Rs=.5*200/W

EQUATION Cgs=0.2*W/200 EQUATION Cgd=0.04*W/200 EQUATION Lg=0.03*200/W

EQUATION Ld=0.03*200/W EQUATION Ls=0.01*200/W EQUATION Rc=500*200/W



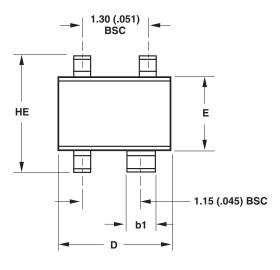
W=800 μm

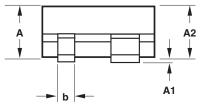
Part Number Ordering Information

No. of			
Part Number	Devices	Container	
ATF-34143-TR1G	3000	7" Reel	
ATF-34143-TR2G	10000	13" Reel	
ATF-34143-BLKG	100	antistatic bag	

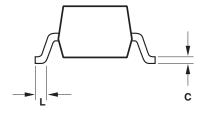
Package Dimensions

SC-70 4L/SOT-343





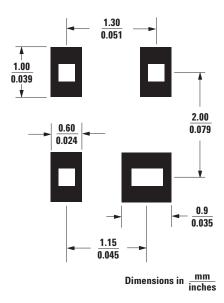
	DIMENSIONS (mm)		
SYMBOL	MIN.	MAX.	
E	1.15	1.35	
D	1.85	2.25	
HE	1.80	2.40	
Α	0.80	1.10	
A2	0.80	1.00	
A1	0.00	0.10	
b	0.25	0.40	
b1	0.55	0.70	
с	0.10	0.20	
L	0.10	0.46	



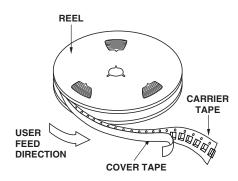
NOTES:

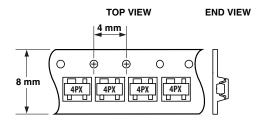
- 1. All dimensions are in mm.
- 2. Dimensions are inclusive of plating.
- 3. Dimensions are exclusive of mold flash & metal burr.
- 4. All specifications comply to EIAJ SC70.
- 5. Die is facing up for mold and facing down for trim/form, ie: reverse trim/form.
- 6. Package surface to be mirror finish.

Recommended PCB Pad Layout for Avago's SC70 4L/SOT-343 Products



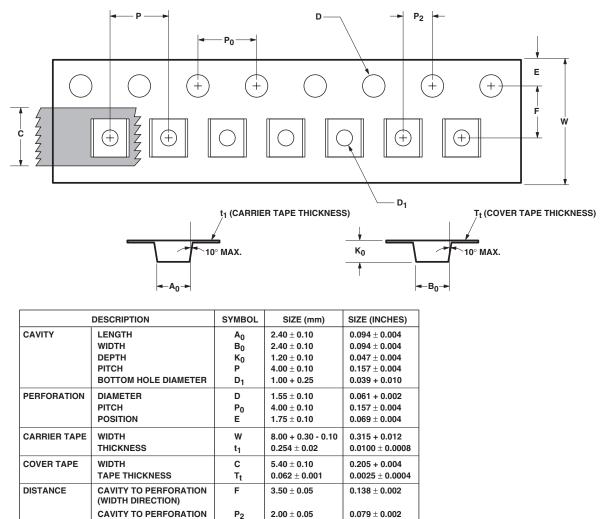
Device Orientation





Tape Dimensions and Product Orientation

For Outline 4T



For product information and a complete list of distributors, please go to our web site:

(LENGTH DIRECTION)

www.avagotech.com

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